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HMC374SC70E

v01.0814

GaAs pHEMT LOW NOISE AMPLIFIER 0.3 - 3.0 GHz

Typical Applications

The HMC374SC70E is ideal for:

- Cellular/PCS/3G
- WCS, MMDS & ISM
- Fixed Wireless & WLAN
- Private Land Mobile Radio

Features

Single Supply: Vdd = +3.0 to +3.6V

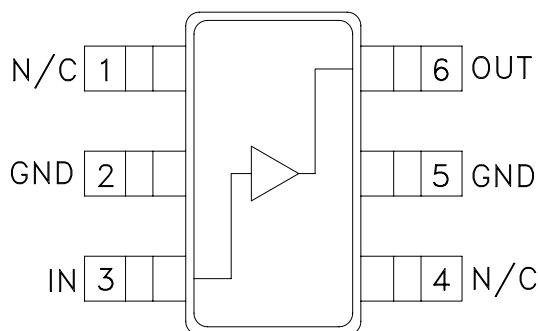
Broadband Performance

Low Noise Figure: 1.6 dB

High Output IP3: +35 dBm

High Gain: 15 dB @ 0.6 GHz

Functional Diagram



General Description

The HMC374SC70E is a general purpose broadband Low Noise Amplifier (LNA) for use in the 0.3 - 3 GHz frequency range. The LNA provides 15 dB of gain and a 1.6 dB noise figure from a single positive supply of +3.0 to +3.6V. The low noise figure coupled with a high P1dB (17 dBm) and high OIP3 (35 dBm) make this part ideal for cellular applications. The compact LNA is designed for repeatable gain and noise figure performance. To minimize board area the design is offered in a low cost SC70E package that occupies only 0.089" x 0.053".

Electrical Specifications, Vdd = +3.3V

Parameter	Min. [2]	Typ. [1]	Max. [2]	Min. [2]	Typ. [1]	Max. [2]	Min. [2]	Typ. [1]	Max. [2]	Units
Frequency		0.6			1.0			3.0		GHz
Gain	14	15		13	14.5		6	8.5		dB
Gain Variation Over Temperature (-40°C to +25°C)		0.005			0.008			0.012		dB/°C
Gain Variation Over Temperature (+25 °C to +85 °C)		0.004			0.005			0.008		
Noise Figure		2	2.6		1.6	2.3		1.8	2.2	dB
Input Return Loss	4.5	5.5		6	7.5		8	9		
Output Return Loss	5.5	7.5		8	10		13	15		
Output 1 dB Compression (P1dB)	15.5	16.5		16	17		16.5	18		dBm
Saturated Output Power (Psat)	17.5	18.5		17.5	18.5		18	19		
Output Third Order Intercept (OIP3)		34			33.5			36		
Supply Current (Idd) (Vdd = +3.3V)		75			75			75		mA
Supply Voltage (Vdd)	3.0	3.3	3.6	3.0	3.3	3.6	3.0	3.3	3.6	V

[1] Typical values are determined at T_A = +25°C

[2] Minimum and maximum values are determined from T_A = -40°C to T_A = +85°C

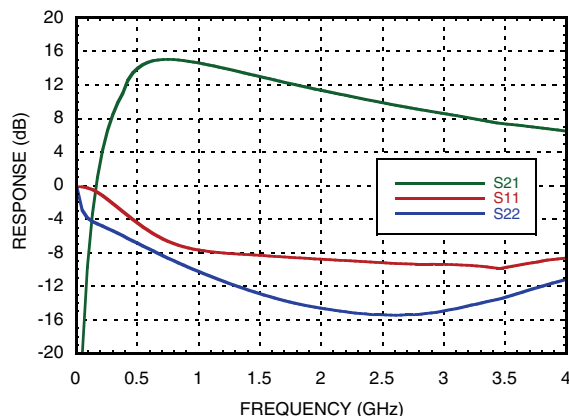
For price, delivery and to place orders: Analog Devices, Inc., 2 Elizabeth Drive, Chelmsford, MA 01824

Phone: 978-250-3343 • Fax: 978-250-3373 • Order On-line at www.hittite.com

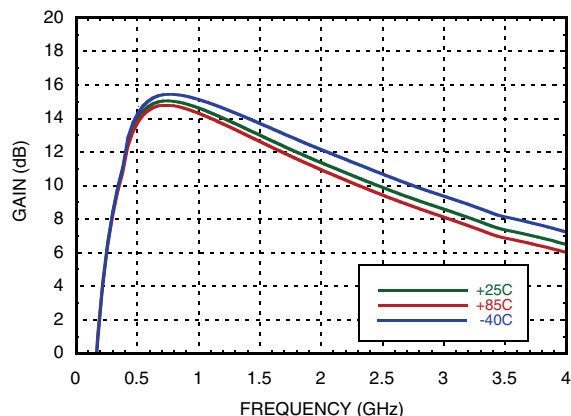
Application Support: Phone: 978-250-3343 or apps@hittite.com

GaAs pHEMT LOW NOISE AMPLIFIER 0.3 - 3.0 GHz

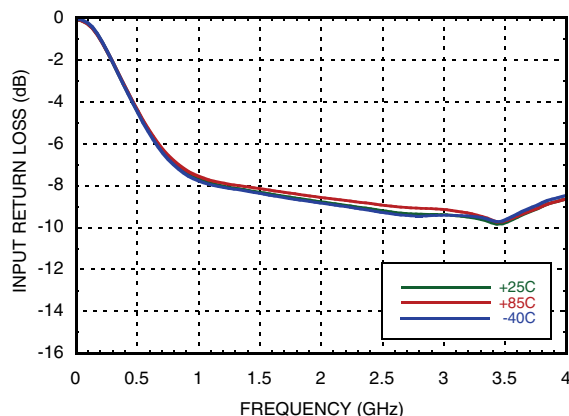
Broadband Gain & Return Loss



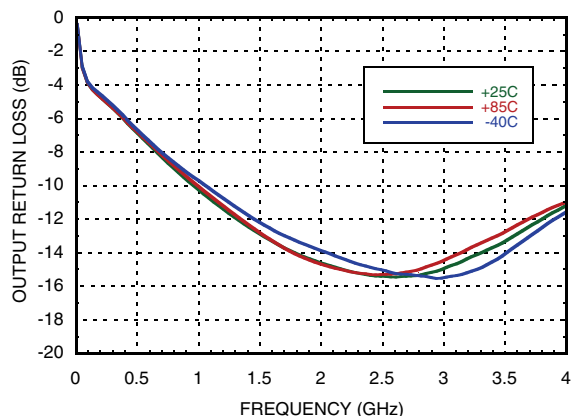
Gain vs. Temperature



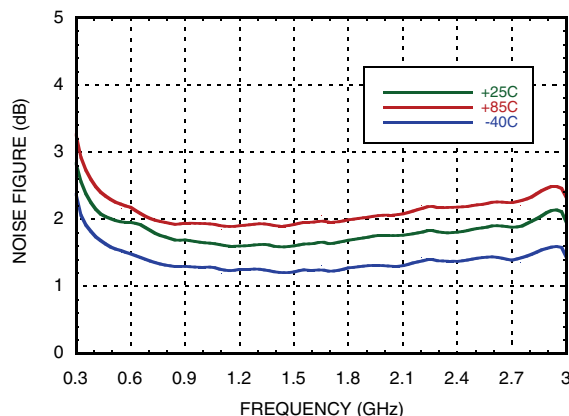
Input Return Loss vs. Temperature



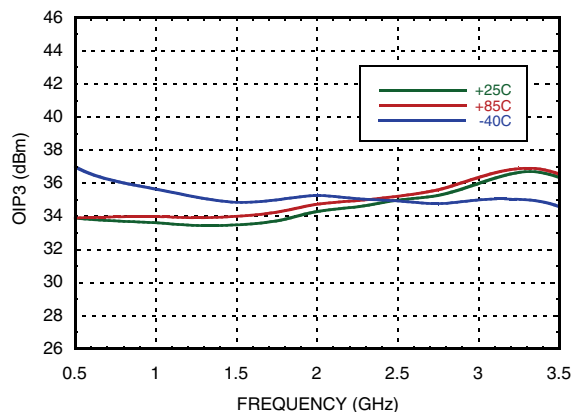
Output Return Loss vs. Temperature



Noise Figure vs. Temperature



Output IP3 vs. Temperature ^[1]



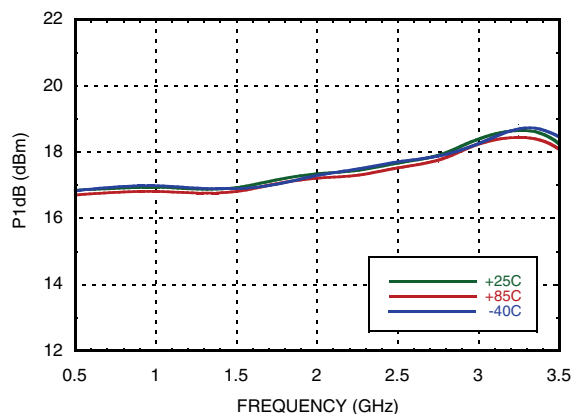
[1] OIP3 measurements were taken for Pout = 0 dBm

HMC374SC70E

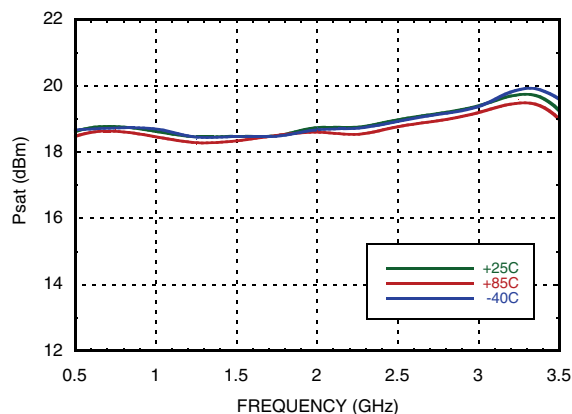
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GaAs pHEMT LOW NOISE AMPLIFIER 0.3 - 3.0 GHz

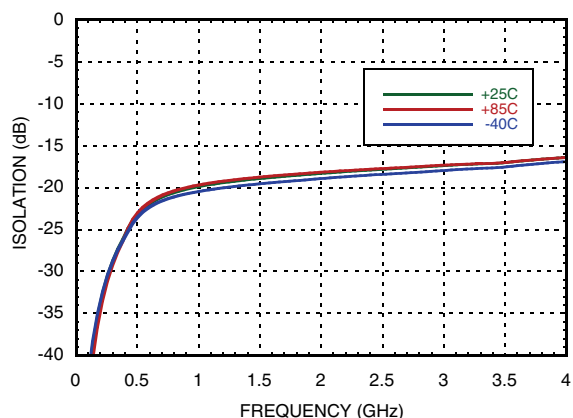
Output P1dB vs. Temperature



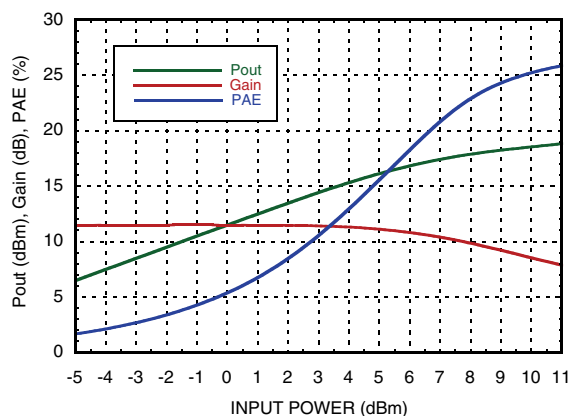
Output Psat vs. Temperature



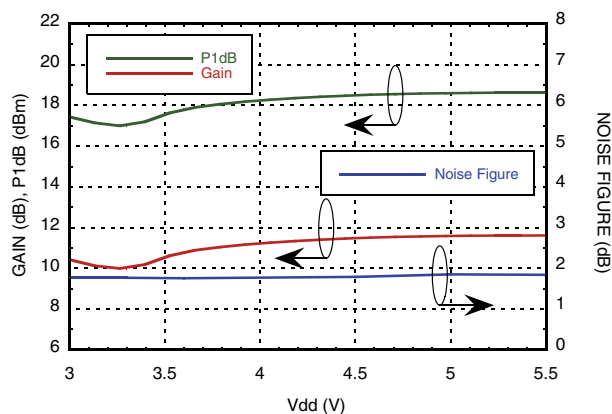
Reverse Isolation vs. Temperature



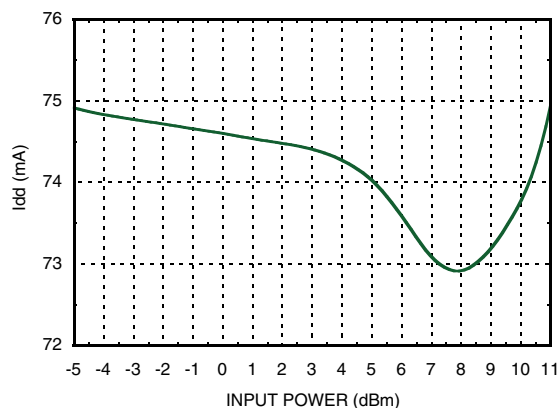
Pout, Gain & PAE @ 2 GHz



Gain, Noise Figure & P1dB vs. Supply Voltage @ 2 GHz



Supply Current vs. Input Power @ 2 GHz



GaAs pHEMT LOW NOISE AMPLIFIER
0.3 - 3.0 GHz

Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+7.0 Vdc
RF Input Power (RFIN)(Vdd = +5.0 Vdc)	15 dBm
Channel Temperature	150 °C
Continuous P _{diss} (T = 85 °C) (derate 4.88 mW/°C above 85 °C)	0.32 W
Thermal Resistance (channel to lead)	205 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 0

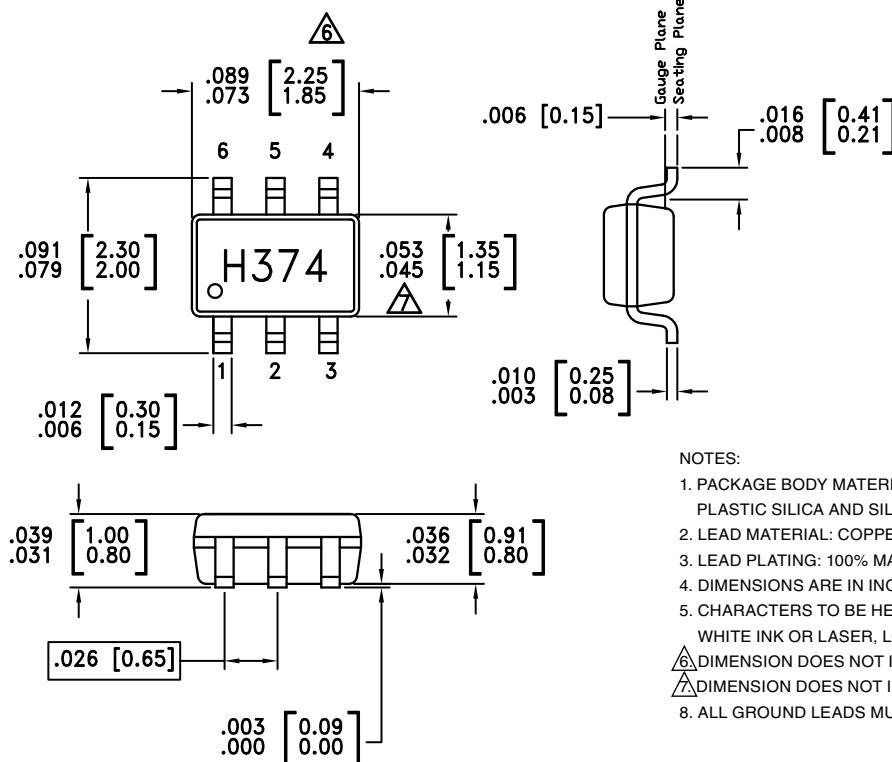
Typical Supply Current vs. Vdd

Vdd (V)	Idd (mA)
3	75
3.3	75
3.6	75



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
2. LEAD MATERIAL: COPPER ALLOY
3. LEAD PLATING: 100% MATTE TIN.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS]
5. CHARACTERS TO BE HELVETICA MEDIUM, .015 HIGH, WHITE INK OR LASER, LOCATED APPROXIMATELY AS SHOWN.
6. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
7. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
8. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

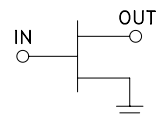
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC374SC70E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H374E XXXX

[1] Max peak reflow temperature of 235 °C

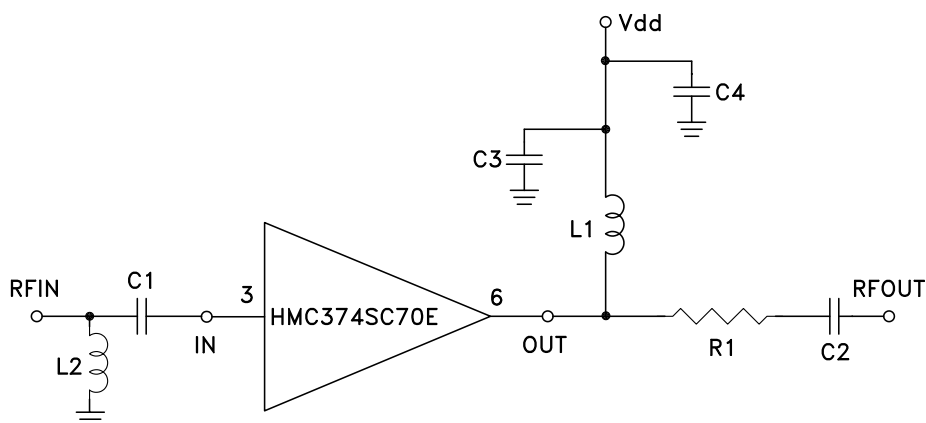
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

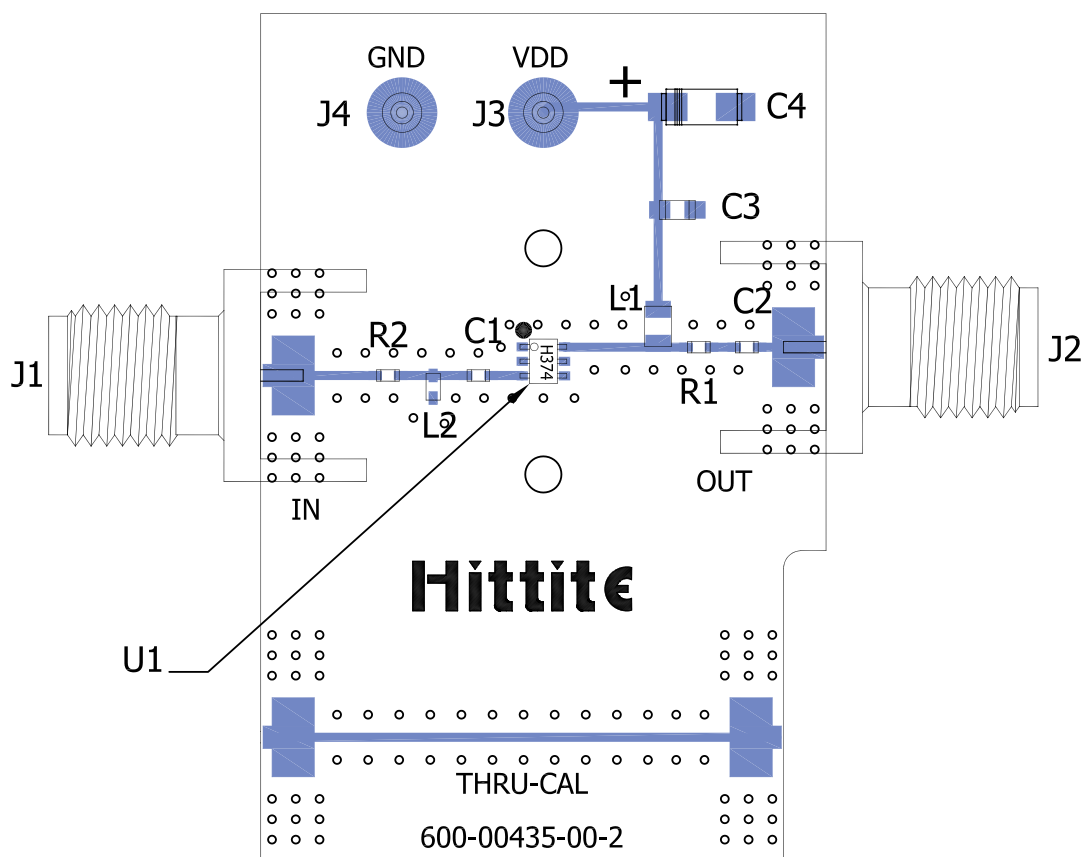
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1,4	N/C	These pins may be connected to RF/DC ground. Performance will not be affected.	
2, 5	GND	These pins must be connected to RF/DC ground.	
3	IN	RF input pin is DC coupled. An off-chip DC blocking capacitor is required.	
6	OUT	RF output and DC Bias for the output stage. See application circuit for off-chip components.	

Application Circuit



Evaluation PCB



List of Materials for EVAL01-HMC374SC70E [1]

Item	Description
J1, J2	PCB Mount SMA Connector
J3, J4	DC Pin
C1	27 pF Capacitor, 0402 Pkg.
C2	150 pF Capacitor, 0402 Pkg.
C3	10 nF Capacitor, 0603 Pkg.
C4	4.7 Capacitor, Tantalum
L1	27 nH Inductor, 0603 Pkg.
L2	22 nH Inductor, 0402 Pkg.
R1	10 Ohms Resistor, 0402 Pkg.
R2	0 Ohm Resistor, 0402 Pkg.
U1	HMC374SC70E Amplifier
PCB [2]	600-00435-00 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Roger 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown above. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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